

# N-Channel 200 V (D-S) MOSFET

PRODUCT	SUMMARY	
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)
200	0.270 at V <sub>GS</sub> = 10 V	8

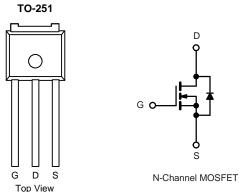
## **FEATURES**

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



## APPLICATIONS

· Primary Side Switch



ABSOLUTE MAXIMUM RATINGS $(T_A = 1)$	25 °C, unless othe	rwise noted)		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage Gate-Source Voltage		V <sub>DS</sub>	200	V
		V <sub>GS</sub>	± 20	]
Continuous Drain Current (T <sub>.I</sub> = 175 °C) <sup>b</sup>	T <sub>C</sub> = 25 °C	I-	8	
Continuous Drain Current $(1_J = 175^{\circ}C)^2$	T <sub>C</sub> = 125 °C	I <sub>D</sub>	5	
Pulsed Drain Current	<u> </u>	I <sub>DM</sub>	25	А
Continuous Source Current (Diode Conduction)		I <sub>S</sub>	5	1
Avalanche Current		I <sub>AS</sub>	5	
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	18	mJ
Maximum Power Dissination	T <sub>C</sub> = 25 °C P <sub>D</sub> 96 <sup>b</sup>	W		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		3 <sup>a</sup>	] vv
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
lunation to Ambient	t ≤ 10 s	R <sub>thJA</sub>	15	18	
Junction-to-Ambient <sup>a</sup>	Steady State	- ► thJA	40	50	°C/W
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.85	1.1	

## Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current	$I_{DSS}$	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μΑ
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	40			Α
		$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		0.270		
Danie Course On Chata Besistance	R	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 125 °C		0.300		0
Drain-Source On-State Resistance <sup>D</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 175 °C		0.320		Ω S
		$V_{GS} = 6 \text{ V}, I_D = 3 \text{ A}$		0.310		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3 A		35		S
Dynamic <sup>a</sup>						
Input Capacitance	C <sub>iss</sub>			800		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, F = 1 MHz		100		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			50		
Total Gate Charge <sup>c</sup>	$Q_g$			34	51	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		8		nC
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			12		
Gate Resistance	R <sub>g</sub>		0.5		2.9	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_{L} = 5.2 \Omega$		50	75	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 3 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		30	45	ns
Fall Time <sup>c</sup>	t <sub>f</sub>			60	90	
Source-Drain Diode Ratings and Char	acteristics (7	<sub>C</sub> = 25 °C)				
Pulsed Current	I <sub>SM</sub>				5	Α
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	I <sub>F</sub> = 3 A, V <sub>GS</sub> = 0 V		0.9	1.5	V
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 3 A, dI/dt = 100 A/µs		180	250	ns

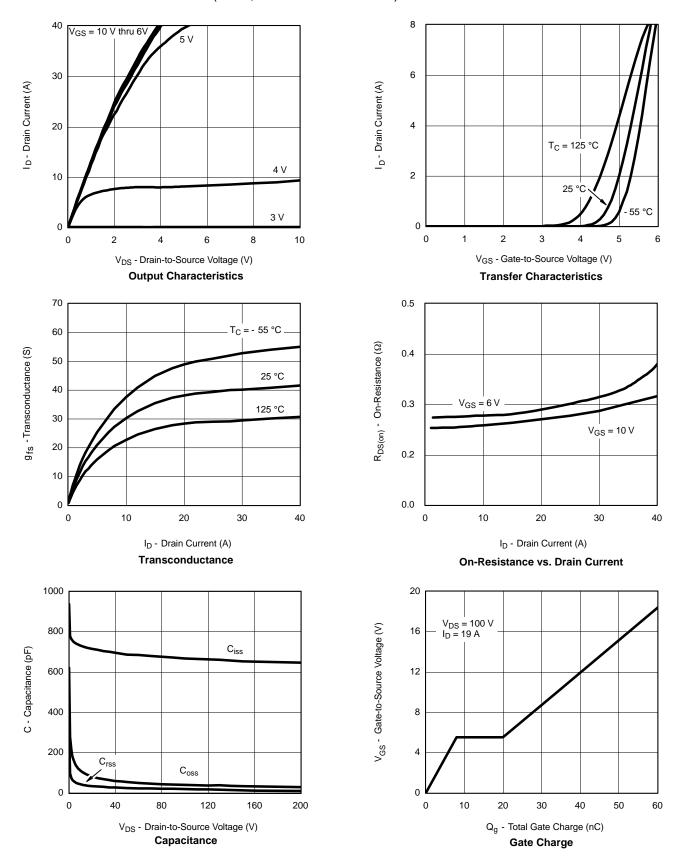
## Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

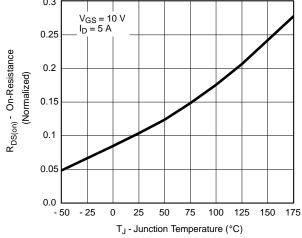


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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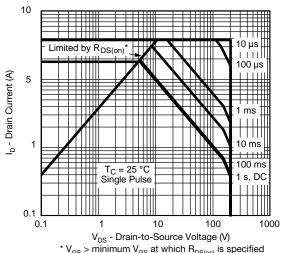
# $T_{J} = 150 \, ^{\circ}\text{C}$ $T_{J} = 25 \, ^{\circ}\text{C}$ $V_{SD} - \text{Source-to-Drain Voltage (V)}$

Source-Drain Diode Forward Voltage

## THERMAL RATINGS

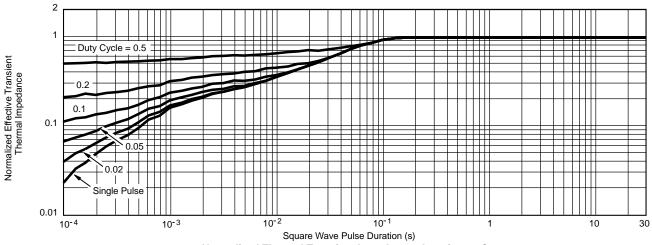


Maximum Avalanche Drain Current vs. Case Temperature



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

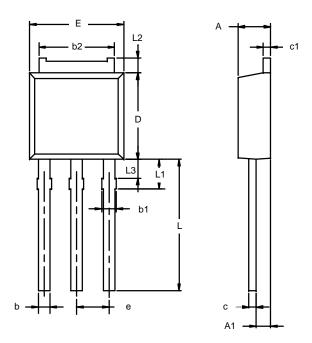
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case



## **TO-251AA**



Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES	
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090	BSC
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060



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